

Terminology

Table 1. Terms and Definitions (Sheet 1 of 8)

Term	Definition
Ack	Acknowledge
ACPI	Advanced Configuration and Power Interface
Addr	Address
Advanced Package	This packaging technology is used for performance optimized applications and short reach interconnects.
AFE	Analog Front End
ALMP	ARB/MUX Link Management Packet (as defined in <i>CXL Specification</i>)
APMW	Advanced Package Module Width
ARB/MUX	Arbiter/Multiplexer (as defined in <i>CXL Specification</i>)
Asset	Any data or mechanism used to access data that should be protected from illicit access, use, availability, disclosure, alteration, destruction, or theft.
ATE	Automated Test Equipment
B2B	Back-to-Back
BAR	Base Address Register
BDF	Bus Device Function
BE	Byte Enable
BEI	BAR Equivalent Indicator
BER	Bit Error Ratio
BFM	Bus Functional Model
bubble	Gap in data transfer and/or signal transitions. Measured in number of clock cycles.
bundle	Tx group or Rx group for UCIE-3D interconnects that contains data, clock, power, and ground. A 3D Module consists of a Tx bundle and an Rx bundle.
C4 bump	Controller Collapse Chip Connect bump
CA	Completer Abort
CDM	Charged Device Model
chiplet	Integrated circuit die that contains a well-defined subset of functionality that is designed to be combined with other chiplets in a package.
clear cleared	If clear or reset is used and no value is provided for a bit, it is interpreted as 0b.
CLM	Current Lane Map
CMLS	Common Maximum Link Speed
CoWoS	Chip on Wafer on Substrate
CPU	Central Processing Unit
CRC	Cyclic Redundancy Check
CXL	Compute eXpress Link
CXL 68B Flit Mode	This term is used to reference 68B Flit Mode related Protocol features defined in <i>CXL Specification</i> .
CXL 256B Flit Mode	This term is used to reference 256B Flit Mode related Protocol features defined in <i>CXL Specification</i> .
D2C	Data-to-Clock
D2D	Die-to-Die
DCC	Duty Cycle Correction

Table 1. Terms and Definitions (Sheet 2 of 8)

Term	Definition
DDR	Double Data Rate Memory
DevID	Device ID
DFx	Design for Debug or Design for Test
DLLP	Data Link Layer Packet (as defined in <i>PCIe Base Specification</i>)
DLP	In Flit modes, the Data Link Layer Payload within a flit (as defined in <i>PCIe Base Specification</i>).
DMH	DFx Management Hub. DFx entity that provides enumeration/global control/status of DFx capabilities in a chiplet.
DMS	DFx Management Spoke. DFx entity that implements a specific test/debug functionality within a DMH .
DMS-ID	Static design time ID assigned to a DMS for ID-routed messages within a DMH . Interchangeably used with the term Spoke-ID.
Domain Reset (domain reset)	Used to refer to a hardware mechanism that sets or returns all UCIE registers and state machines associated with a given UCIE Link to their initialization values as specified in this document. It is required for both sides of the Link to have an overlapping time window such that they are both in domain reset concurrently.
DP	Downstream Port
DSP	Downstream Switch Port (as defined in <i>CXL Specification</i>)
DVFS	Dynamic Voltage Frequency Scaling
DVSEC	Designated Vendor-Specific Extended Capability (as defined in <i>PCIe Base Specification</i>)
DWORD	Double Word. Four bytes. When used as an addressable quantity, a Double Word is four bytes of data that are aligned on a four-byte boundary (i.e., the least significant two bits of the address are 00b).
E2E	End to end
EM	Eye Margin
EMIB	Embedded Multi-die Interconnect Bridge
EML	Eye Margin Left
EMR	Eye Margin Right
EMV	Eye Margin Valid
Encapsulated MTP eMTP	Encapsulated Management Transport Packet. The resulting packet after Encapsulation .
Encapsulation	Process of splitting an MTP or Vendor defined messages (exchanged between Management Port Gateways on both ends of a link) into smaller pieces to meet any required payload length restrictions or for any other reasons like credit availability, adding a 2-DWORD header to each piece and if required, adding a 1-DWORD data padding at the end of an MTP to transmit the MTP over sideband or mainband UCIE link. In the case of an MTP, the resulting packet after Encapsulation is called the Encapsulated MTP.
Endpoint EP	As defined in <i>PCIe Base Specification</i> .
eRCD	Exclusive Restricted CXL Device (as defined in <i>CXL Specification</i>)
eRCH	Exclusive Restricted CXL Host (as defined in <i>CXL Specification</i>)
ESD	Electro-Static Discharge
F2B	Face-to-Back
F2F	Face-to-Face
FDI	Flit-Aware Die-to-Die Interface
FEC	Forward Error Correction
FEXT	Far-End CrossTalk
FH	Flit Header

Table 1. Terms and Definitions (Sheet 3 of 8)

Term	Definition
FIFO	First In, First Out
FIR	Finite Impulse Response
FIT	Failure In Time. 1 FIT = 1 device failure in 10 ⁹ hours.
Flit	Link Layer unit of transfer (as defined in <i>CXL Specification</i>).
Flit_Marker FM	Flit Marker (as defined in <i>PCIe Base Specification</i>)
FW	Firmware
FW-CLK	Forwarded Clock over the UCIE Link for mainband data Lanes
HMLS	Highest Maximum Link Speed of next-lower configuration.
Hub	See DMH .
HW	Hardware
IL	Insertion Loss
I/O	Input/Output
IP	Generic term used to refer to architecture blocks that are defined within the specification (e.g., D2D adapter, PHY, etc.).
IPA	Ignore Prohibited Access
ISI	Inter-Symbol Interference
KPI	Key Performance Indicator
Lane	A pair of signals mapped to physical bumps, one for Transmission, and one for Reception. A xN UCIE Link is composed of N Lanes.
LCLK	Refers to the clock at which the Logical Physical Layer, Adapter and RDI/FDI are operating.
LCRC	Link CRC
LFSR	Linear Feedback Shift Register
Link UCIE Link	A Link or UCIE Link refers to the set of two UCIE components and their interconnecting Lanes which forms a dual-simplex communications path between the two components.
LSM	Adapter Link State Machine
LTSM	Link Training State Machine
LTSSM	Link Training and Status State Machine (as defined in <i>PCIe Base Specification</i>)
LSB	Least Significant Bit
Mainband MB	Connection that constitutes the main data path of UCIE. Consists of a forwarded clock, a data valid pin, and N Lanes of data per module.
Management Bridge	Type of Management Entity that bridges a Management Network within an SiP to another network that may be internal or external to the SiP.
Management Director	Management Element that is responsible for discovering, configuring, and coordinating the overall management of the SiP and acts as the manageability Root of Trust (RoT).
Management Domain	One or more chiplets in an SiP that are interconnected by a Management Network and support UCIE Manageability.
Management Element	Type of Management Entity that can perform one or more management functions.
Management Entity	Addressable entity on the Management Network that can send and/or receive UCIE Management Transport packets. A Management Element, a Management Port, and a Management Bridge are all a type of Management Entity.
Management Flit	A Flit that carries a Management Port Message (MPM) .
Management Link Encapsulation Mechanism	Mechanism that defines how UCIE Management Transport packets are transferred across a point-to-point management link.

Table 1. Terms and Definitions (Sheet 4 of 8)

Term	Definition
Management Network	Network within and between chiplets that is capable of transporting UCIE Management Transport packets.
Management Port	Management Entity that facilitates management communication between chiplets using a chiplet-to-chiplet management link.
Management Port Gateway (MPG)	Entity that provides the bridging functionality when transporting an MTP from/to a local SoC management fabric (which is an SoC-specific implementation) to/from a UCIE link.
Management Port Message (MPM)	Sideband or mainband message that relates to encapsulation.
Management Protocol	Protocol carried on top of the UCIE Management Transport.
Management Reset	Type of reset that causes all UCIE manageability and manageability structures in a chiplet to be reset to their default state.
MCLS	Number of active Modules Current Link Speed
MMIO	Memory mapped Input/Output
MMPL	Multi-module PHY Logic
Module	UCIE main data path on the physical bumps is organized as a group of Lanes called a Module. For Standard Package, 16 Lanes constitute a single Module. For Advanced Package, 64 Lanes constitute a single Module.
MSB	Most Significant Bit
MTP	Management Transport Packet
Nak	Negatively acknowledge
NEXT	Near-End CrossTalk
NOP	No Operation
NVMe	Non-Volatile Memory express
One-Time Programmable	Any data storage mechanism that is capable of being programmed only once (e.g., fuse).
P2P	Peer to peer
Packet	A block of data transmitted across a network.
PCIe (PCI Express)	Peripheral Component Interconnect Express (defined in <i>PCIe Base Specification</i>)
PCIe Flit Mode	This term is used to reference Flit Mode related Protocol features defined in <i>PCIe Base Specification</i> .
PCIe non-Flit Mode	This term is used to reference non-Flit Mode related Protocol features defined in <i>PCIe Base Specification</i> .
PDOS	Permanent Denial of Service
PDS	Pause of Data Stream
PHY	Physical Layer (PHY and Physical Layer are used interchangeably throughout the Specification)
PI	Phase Interpolator
PLL	Phase-Locked Loop
PM	Power Management states, used to refer to behavior and/or rules related to Power Management states (covers both L1 and L2).
PMO	Sideband Performant Mode Operation
QWORD	Quad Word. Eight bytes. When used as an addressable quantity, a Quad Word is eight bytes of data that are aligned on an eight-byte boundary (i.e., the least significant three bits of the address are 000b).
RAC	Read Access Control
RCD	Restricted CXL Device (as defined in <i>CXL Specification</i>)
RCH	Restricted CXL Host (as defined in <i>CXL Specification</i>)
RCIEP	Root Complex Integrated Endpoint

Table 1. Terms and Definitions (Sheet 5 of 8)

Term	Definition
RCKN_P RXCKN rxckn	Physical Lane for Clock Receiver Phase-2
RCKP_P RXCKP rxckp	Physical Lane for Clock Receiver Phase-1
RCRB	Root Complex Register Block
RDI	Raw Die-to-Die Interface
RD_P[N] RD_PN RXDATA[N] rxdataN	Nth Physical Lane for Data Receiver
remote Link partner	This term is used throughout this specification to denote the logic associated with the far side of the UCIE Link; to denote actions or messages sent or received by the Link partner of a UCIE die.
Replay Retry	Retry and Replay are used interchangeably to refer to the Link level reliability mechanisms.
Reserved	<p>The contents, states, or information are not defined at this time. Using any Reserved area (for example, packet header bit-fields, configuration register bits) is not permitted. Reserved register fields must be read only and must return 0 (all 0s for multi-bit fields) when read. For packets transmitted and received over the UCIE Link (mainband or sideband), the Reserved bits must be cleared to 0b by the sender and ignored by the receiver. Reserved encodings for register and packet fields must not be used. Any implementation dependence on a Reserved field value or encoding will result in an implementation that is not UCIE-compliant. The functionality of such an implementation cannot be guaranteed in this or any future revision of this specification.</p> <p>For registers, UCIE uses the "RsvdP" or "RsvdZ" attributes for reserved fields, as well as Rsvd, and these follow the same definition as PCIe Base Specification for hardware as well as software.</p>
reset	If reset or clear is used and no value is provided for a bit, it is interpreted as 0b.
RID	Revision ID
RL	Register Locator
Root Complex	As defined in <i>PCIe Base Specification</i> .
Root Port RP	As defined in <i>PCIe Base Specification</i> .
RoT	Root of Trust
RRDCK_P RXCKRD rxckRD	Physical Lane for redundant Clock/Track Receiver
RRD_P[N] RRD_PN RXDATARD[N] rxdataRD[N]	Nth Physical Lane for redundant Data Receiver
RRDVL_D_P RXVLDRD rxvldRD	Physical Lane for redundant Valid Receiver
RTRK_P RXTRK rxtrk	Physical Lane for Track Receiver
RVLD_P RXVLD rxvld	Physical Lane for Valid Receiver
Rx	Receiver

Table 1. Terms and Definitions (Sheet 6 of 8)

Term	Definition
RXCKSB rxcksb	Physical Lane for sideband Clock Receiver
RXCKSBRD rxcksbRD	Physical Lane for redundant sideband Clock Receiver
RXDATASB rxdatasb	Physical Lane for sideband Data Receiver
RXDATASBRD rxdatasbRD	Physical Lane for redundant sideband Data Receiver
SBFE	Sideband Feature Extensions
{<SBMSG>}	Sideband message requests or responses are referred to by their names enclosed in curly brackets. See Chapter 7.0 for the mapping of sideband message names to relevant encodings. An asterisk in the <SBMSG> name is used to denote a group of messages with the same prefix or suffix in their name.
SC	Successful Completion
SD	Security Director. Management Element that may configure security parameters.
Segmentation	Process of taking a large MTP , splitting it into smaller “segments” and sending those segments on multiple sideband links or mainband stacks.
SERDES	Serializer/Deserializer
serial packet	A 64-bit serial packet is defined on the sideband I/O interface to the remote chiplet as shown in Figure 4-8 .
set	If set is used and no value is provided for a bit, it is interpreted as 1b.
SFES	Sideband Feature Extensions Supported
Sideband SB	Connection used for parameter exchanges, register accesses for debug/compliance and coordination with remote partner for Link training and management. Consists of a forwarded clock pin and a data pin in each direction. The clock is fixed at 800 MHz regardless of the main data path speed. The sideband logic for the UCIE Physical Layer must be on auxiliary power and an “always on” domain. Each module has its own set of sideband pins.
SIP	System in Package. Collection of chiplets packaged as a unit.
SM	State Machine
SO	Sideband-only
SoC	System on a Chip
Spoke	See DMS .
Standard Package	This packaging technology is used for low cost and long reach interconnects using traces on organic package/substrate
Strobe	Used interchangeably with clock for sideband clock
SW	Software
TC	Traffic Class
TCKN_P TXCKN txckn	Physical Lane for Clock Transmitter Phase-2
TCKP_P TXCKP txckp	Physical Lane for Clock Transmitter Phase-1
TCM	Tightly coupled mode
TDPI	Test, Debug, Pattern, and Infrastructure

Table 1. Terms and Definitions (Sheet 7 of 8)

Term	Definition
TD_P[N] TD_PN TXDATA[N] txdataN	Nth Physical Lane for Data Transmitter
TLP	Transaction Layer Packet (as defined in <i>PCIe Base Specification</i>)
TRD_P[N] TRD_PN TXDATARD[N] txdataRD[N]	Nth Physical Lane for redundant Data Transmitter
TRDCK_P TXCKRD txckRD	Physical Lane for redundant Clock/Track Transmitter
TRDVLD_P TXVLDRD txvldRD	Physical Lane for redundant Valid Transmitter
Trx	Transceiver
TSV	Through-Silicon Via
TTRK_P TXTRK txtrk	Physical Lane for Track Transmitter
TVLD_P TXVLD txvld	Physical Lane for Valid Transmitter
Tx	Transmitter
TXCKSB txcksb	Physical Lane for sideband Clock Transmitter
TXCKSBRD txcksbRD	Physical Lane for redundant sideband Clock Transmitter
TXDATASB txdatasb	Physical Lane for sideband Data Transmitter
TXDATASBRD txdatasbRD	Physical Lane for redundant sideband Data Transmitter
TXEQ	Transmitter Equalization
UCIe	Universal Chiplet Interconnect express
UCIe-3D	Universal Chiplet Interconnect express for 3D packaging
UCIe-A	Used to denote x64 Advanced Package module.
UCIe-A x32	Used to denote x32 Advanced Package module. See Chapter 5.0 for UCIe-A x32 Advanced Package bump matrices, and interoperability between x32 to x32 and x32 to x64 module configurations.
UCIe-S	Used to denote x16 Standard Package module.
UCIe chiplet	A chiplet that complies with the UCIe specification.
UCIe DfX Architecture UDA	DfX architecture specified for chiplets and SiPs that implement UCIe.
UCIe DfX Message UDM	Generic term for all UCIe Management Transport packets with Protocol ID set to 'Test and Debug Protocols'.
UCIe die	This term is used throughout this specification to denote the logic associated with the UCIe Link on any given chiplet with a UCIe Link connection. It is used as a common noun to denote actions or messages sent or received by an implementation of UCIe.

Table 1. Terms and Definitions (Sheet 8 of 8)

Term	Definition
UCIe Flit Mode	Operating Mode in which CRC bytes are inserted and checked by the D2D Adapter. If applicable, Retry is also performed by the D2D Adapter.
UCIe Link	A UCIe connection between two chiplets. These chiplets are Link partners in the context of UCIe since they communicate with each other using a common UCIe Link.
UCIe Mainband Management Port	Chiplet port that implements the Management Link Encapsulation Mechanism and can transfer UCIe Management Transport packets across a point-to-point UCIe mainband link.
UCIe Management Transport Protocol	Protocol used to transfer UCIe Management Transport packets between management entities.
UCIe Raw Format	Operating format in which all the bytes of a Flit are populated by the Protocol Layer.
UCIe Sideband Management Port	Chiplet port that implements the Management Link Encapsulation Mechanism and can transfer UCIe Management Transport packets across a point-to-point UCIe sideband link.
UCLS	UCIe Link Structure
UEDT	UCIe Early Discovery Table
UHM	UCIe Link Health Monitor
UIE	Uncorrectable Internal Error
UIRB	UCIe Register Block
UISRB	UCIe Structure Register Block
UMAP	UCIe Memory Access Protocol
Unit Interval UI	Given a data stream of a repeating pattern of alternating 1 and 0 values, the Unit Interval is the value measured by averaging the time interval between voltage transitions, over a time interval sufficiently long to make all intentional frequency modulation of the source clock negligible.
UP	Upstream Port
UR	Unsupported Request
USP	Upstream Switch Port
VH	Virtual Hierarchy (as defined in <i>CXL Specification</i>)
vLSM	Virtual Link State Machine
Vref	Reference voltage for receivers
VTF	Voltage Transfer Function
WAC	Write Access Control
zero	Numerical value of 0 in a bit, field, or register, of appropriate width for that bit, field, or register.

Table 2. Unit of Measure Symbols

Symbol	Unit of Measure
b	bit
B	byte
dB	decibel
fF	femtofarad
GB/s	gigabytes per second
GHz	gigahertz
GT/s	gigatransfers per second
KB/s	kilobytes per second
MB/s	megabytes per second
MHz	megahertz
mm	millimeter
ms	millisecond
MT/s	megatransfers per second
mUI	milli-Unit interval
mV	millivolt
mVpp	millivolt peak-to-peak
um	micrometer
us	microsecond
ns	nanosecond
pJ	picojoule
pk	peak
ppm	parts per million
ps	picosecond
s	second
TB/s	terabytes per second
V	volt